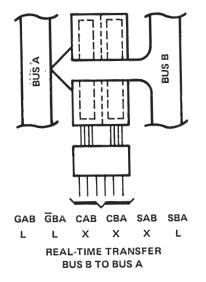
SN54LS651 THRU SN54LS653 SN74LS651 THRU SN74LS653 OCTAL BUS TRANSCEIVERS AND REGISTERS SDLS191A – JANUARY 1981 – REVISED DECEMBER 2000

- Bus Transceivers/Registers
- Independent Registers and Enables for A and B Buses
- Multiplexed Real-Time and Stored Data
- Choice of True and Inverting Data Paths
- Choice of 3-State or Open-Collector Outputs to A Bus
- Dependable Texas Instruments Quality and Reliability

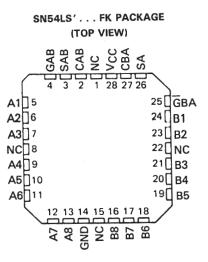
DEVICE	A OUTPUT	B OUTPUT	LOGIC
'LS651	3-State	3-State	Inverting
'LS652	3-State	3-State	True
'LS653	Open-collector	3-State	Inverting

description

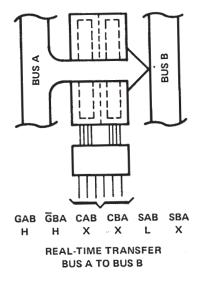
These devices consist of bus transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. Enable GAB and $\overline{G}BA$ are provided to control the transceiver functions. SAB and SBA control pins are provided to select whether realtime or stored data is transferred. A low input level selects real-time data, and a high selects stored data. The following examples demonstrate the four fundamental bus-management functions that can be performed with the 'LS651, 'LS652, and 'LS653.



SN54LS'... JT PACKAGE SN74LS'... DW OR NT PACKAGE (TOP VIEW)



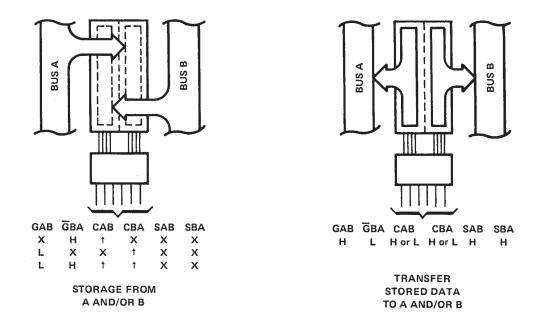
NC - No internal connection



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SN54LS651 THRU SN54LS653 SN74LS651 THRU SN74LS653 OCTAL BUS TRANSCEIVERS AND REGISTERS

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Data on the A or B data bus, or both, can be stored in the internal D flip-flop by low-to-high transitions at the appropriate clock pins (CAB or CBA) regardless of the select or enable control pins. When SAB or SBA are in the real-time transfer mode, it is also possible to store data without using the internal D-type flip-flops by simultaneously enabling GAB and GBA. In this configuration each output reinforces its input. Thus, when all other data sources to the two sets of bus lines are at high impedance, each set of bus lines will remain at its last state.

The SN54LS651 through SN54LS653 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LS651 through SN74LS653 are characterized for operation from 0°C to 70°C.

		INP	UTS			DAT	A I/O*	OPERATION C	R FUNCTION
GAB	ĞВА	CAB	СВА	SAB	SBA	A1 THRU A8	B1 THRU B8	'LS651, 'LS653	'LS652, 'LS654
L	н	H or L	H or L	Х	х	laput	1	Isolation	Isolation
L	Н	+	1	Х	х	Input	Input	Store A and B Data	Store A and B Data
Х	н	1	H or L	Х	Х	Input	Not specified	Store A, Hold B	Store A, Hold B
н	Н	Ť	1	Х	х	Input	Output	Store A in both registers	Store A in both registers
L	Х	H or L	1	X	Х	Not specified	Input	Hold A, Store B	Hold A, Store B
L	L	1	1	Х	Х	Output	Input	Store B in both registers	Store B in both registers
L	L	×	x	Х	L	Output	Input	Real-Time B Data to A Bus	Real-Time B Data to A Bus
L	L	X	H or L	X	Н	Output	mput	Stored B Data to A Bus	Stored B Data to A Bus
н	Н	X	х	L	Х	Input	Output	Real-Time A Data to B Bus	Real-Time A Data to B Bus
н	н	HorL	х	н	Х	mpar	Output	Stored A Data to B Bus	Stored A Data to B Bus
н	· E	Horl	H or L	н	н	Output	Output	Stored A Data to B Bus and	Stored A Data to B Bus and
	.							Stored B Data to A Bus	Stored B Data to A Bus

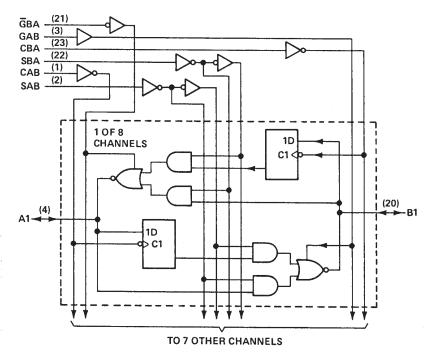
FUNCTION TABLE

* The data output functions may be enabled or disabled by various signals at the GAB and GBA inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low-to-high transition on the clock inputs.

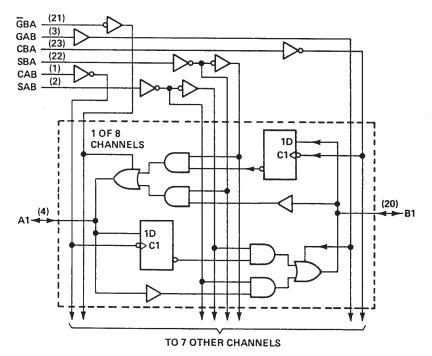


logic diagrams (positive logic)





'LS652

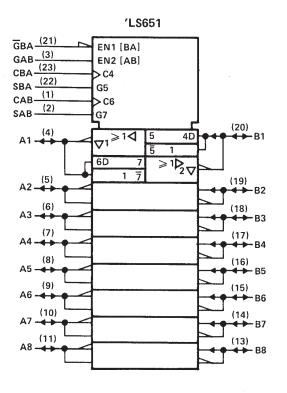


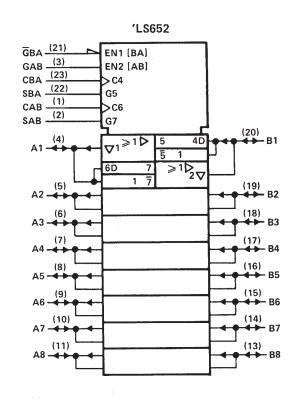
Pin numbers shown are for DW, JT or NT packages.



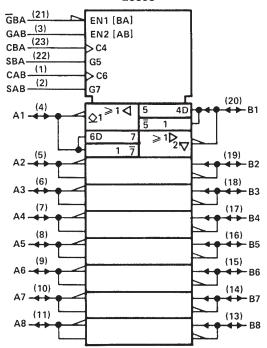
SN54LS651 THRU SN54LS653 SN74LS651 THRU SN74LS653 OCTAL BUS TRANSCEIVERS AND REGISTERS SDLS191A - JANUARY 1981 - REVISED DECEMBER 2000

logic symbols[†]





'LS653



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, JT, or NT packages.



SN54LS651, SN54LS652, SN74LS651, SN74LS652 OCTAL BUS TRANSCEIVERS AND REGISTERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC}
Input voltage: Control inputs
I/O ports 5.5 V
Operating free-air temperature range: SN54LS651, SN54LS652
SN74LS651, SN74LS652
Storage temperature range 65°C to 150°C

recommended operating conditions

				SN54LSE SN54LSE		SN74LS651 SN74LS652			UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX		
Vcc	Supply voltage		4.9	5 5	5,5	4.75	5	5.25	V	
VIH	High-level input voltage		2		2			V		
VIL	Low-level input voltage			0.7			0.8	V		
ЮН	High-level output current			- 12			- 15	mA		
10L	Low-level output current				12			24	mA	
		CBA or CAB high	1	5		15				
tw	Pulse duration	CBA or CAB low	11	5		15			ns	
		Data high or low	1	5		15				
t _{su}	Setup time before CAB↑ or CBA↑	A or B	1!	5		15			ns	
t _h	Hold time after CAB↑ or CBA↑	A or B)		0			ns	
Τ _A	Operating free-air temperature		- 5	5	125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN	154LS65	51	SN	74LS65	51		
PA	ARAMETER	Т	EST CONDITIO	NS [†]	SN	154LS65	2	SN	74LS65	52	UNIT	
					MIN	τγρ‡	MAX	MIN	TYP‡	MAX	1	
		$V_{CC} = MIN,$	lı = — 18 mA				- 1.5			- 1.5	V	
		V _{CC} = MIN,	V _{IH} = 2 V,	I _{OH} = - 3 mA	2.4	3.4		2.4	3.4			
∨он		$V_{11} = MAX,$	VIH - 2 V,	I _{OH} = - 12 mA	2						1 v 1	
				^I OH = - 15 mA				2			1	
VOL		$V_{CC} = MIN,$	V _{IH} = 2 V,	^I OL = 12 mA		0.25	0.4		0.25	0.4		
	VIL = MAX,			IOL = 24 mA					0.35	0.5	l v	
1	Control inputs	$V_{CC} = MAX,$	V ₁ = 7 V				0.1			0.1		
'1	A or B ports	$V_{CC} = MAX,$	V1 = 5.5 V				0.1			0.1	mA	
Чн	Control inputs	V _{CC} = MAX,	V. = 2 7 V				20			20	<u> </u>	
-11	A or B ports¶	VCC - MAA,	v ~ 2.7 v	V ₁ = 2.7 V			20			20	μA	
IIL.	Control inputs	V _{CC} = MAX,	$V_{1} = 0.4 V_{1}$				- 0.4			- 0.4		
11	A or B ports¶		v] = 0.4 v	V I = 0.4 V			- 0.4			- 0.4	mA	
los §		V _{CC} ≕ MAX,	V _O = 0 V		- 40		- 225	- 40		- 225	mA	
				Outputs high		95	145		95	145	1	
	LS651			Outputs low		103	165		103	165	1	
I ICC		V _{CC} = MAX		Outputs disabled	103 165			103	165			
	LS652			Outputs high		95	145		95	145	- mA	
				Outputs low		103	165		103	165	1	
				Outputs disabled		120	180		120	180	1	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at V_{CC} = 5 V, $T_A = 25$ °C. § Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

 \P For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.



SN54LS651, SN54LS652, SN74LS651, SN74LS652 **OCTAL BUS TRANSCEIVERS AND RÉGISTERS**

SDLS191 - JANUARY 1981 - REVISED MARCH 1988

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	FROM	то	TEST COND			'LS651			'LS652		
	(INPUT)	(OUTPUT)	IEST CONL	in lows	MIN	ТҮР	MAX	MIN	ТҮР	MAX	UNIT
^t PLH	Clock	Bus				14	24		15	25	ns
^t PHL		Dus				23	35		24	36	ns
^t PLH	Bus	Bus				9	18		12	18	ns
^t PHL		Dus				20	30		13	20	ns
^t PLH	Select, with bus input					31	47		23	35	ns
tPHL	high [†]	P.u.s	R _L = 667 Ω,	C _L = 45 pF,		22	33		21	32	ns
^t PLH	Select, with bus input	Bus	See Note 2			23	35		33	50	ns
^t PHL	low [†]					19	30		15	23	ns
^t PZH	Ğва	A Bus				29	44		30	45	ns
^t PZL		A Bus				40	60		36	54	ns
^t PZH	GAB	B Bus				19	29		20	30	ns
^t PZL	- GAB	0.003				26	40	-	25	38	ns
^t PHZ	Ğва	A Bus			1	25	38		25	38	ns
^t PLZ	054	~ 303	$R_{L} = 667 \Omega_{s}$	CL = 5 pF,		19	30		19	30	ns
^t PHZ	GAB	B Bus	See Note 2			25	38		25	38	ns
^t PLZ	GAB					19	30		19	30	ns

tpLH = propagation delay time, low-to-high-level output.

tpHL = propagation delay time, high-to-low-level output

tpzH = output enable time to high level

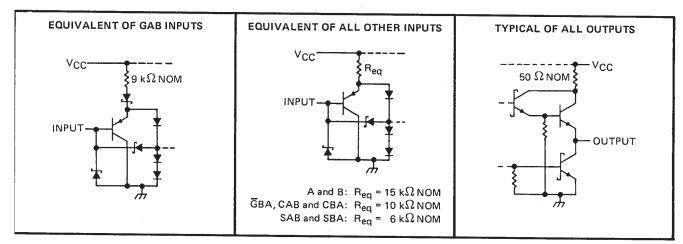
tpzL = output enable time to low level

tpHZ = output disable time from high level

 t_{PLZ}^{T} = output disable time from low level [†] These parameters are measured with the internal output state of the storage register opposite to that of the bus input.

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs





SN54LS653, SN74LS653 OCTAL BUS TRANSCEIVERS AND REGISTERS

SDLS191 - JANUARY 1981 - REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, V _{CC}
Input voltage: All inputs and A I/O ports 7V
B I/O ports 5.5 V
Operating free-air temperature range: SN54LS653
SN74LS653
Storage temperature range

recommended operating conditions

			S	N54LS6	53	SN74LS653		53		
			MIN	NOM	MAX	MIN	NOM	MAX		
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V	
VIH High-level input voltage						2			V	
VIL Low-level input voltage					0.7			0.8	V	
VOH	High-level output voltage	A ports			5.5			5.5	V	
юн	High-level output current	B ports			- 12			- 15	mA	
IOL	Low-level output current				12			24	mA	
		CBA or CAB high	15			15				
tw	Pulse duration	CBA or CAB low	30			30			ns	
		Data high or low	30			30				
t _{su}	Setup time	A or B	15			15			ns	
su	before CAB [↑] or CBA [↑]		10							
t.	Hold time	A or B	0			0			ns	
th	after CAB† or CBA†					0			115	
TA	Operating free-air temperature		- 55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	т	EST CONDITIO	NS [†]	SI	54LS6	53	s	N74LS6	53	UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIK		V _{CC} = MIN,	lı = — 18 mA				- 1.5			- 1.5	V
		V _{CC} = MIN,	V _{IH} = 2 V,	IOH = - 3 mA	2.4	3.4		2.4	3.4		
VOH	B ports	VIL = MAX		IOH = - 12 mA	2						V
				¹ OH = - 15 mA				2			1
юн	A ports	V _{CC} = MIN,	V _{OH} = 5.5 V				0.1			0.1	mA
Vei		V _{CC} = MIN,	VIH = 2 V,	IOL = 12 mA		0.25	0.4		0.25	0.4	v
VOL		VIL = MAX		IOL = 24 mA					0.35	0.5	l v
· 1.	Control inputs	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
Ц	A or B ports	V _{CC} = MAX,	VI = 5.5 V				0.1			0.1	mA
1	Control inputs		V _I = 2.7 V				20			20	
ЧΗ	A or B ports	$V_{CC} = MAX,$					20		-	20	μA
կլ	Control inputs	V _{CC} = MAX,	$V_{1} = 0.4 V$				- 0.4			- 0.4	mA
11	A or B ports	$V_{CC} = WAX,$					- 0.4			- 0.4	1
IOS §	B ports	V _{CC} = MAX,	V ₀ = 0 V		- 40		- 225	- 40		- 225	mA
				Outputs high		95	145		95	145	
	LS653			Outputs low		103	165		103	165]
100		V _{CC} = MAX		Outputs disabled		103	165		103	165	-
lcc				Outputs high		95	145		95	145	mA
	LS654			Outputs low		105	170		105	170	
				Outputs disabled		120	180		120	180	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. [‡] All typical values are at $V_{CC} = 5 V$, $T_A = 25 °C$.

[§] Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

 \P For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.



SN54LS653, SN74LS653 OCTAL BUS TRANSCEIVERS AND REGISTERS

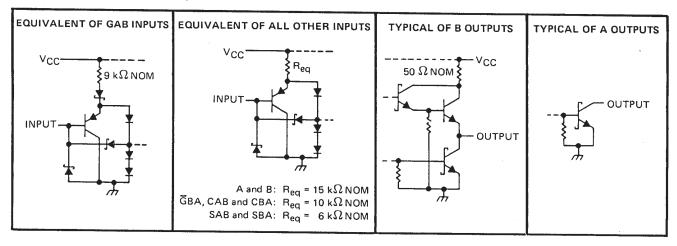
SDLS191 - JANUARY 1981 - REVISED MARCH 1988

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		P MAX	UNIT	
^t PLH	СВА	A D		2!	5 38		
^t PHL	CBA	A Bus		26		ns	
^t PLH	САВ	B Bus		15	5 23		
tPHL		D Dus		24	l 36	ns	
^t PLH	- A Bus	B Bus		10) 18		
^t PHL		D D03		20) 30	ns	
tPLH	- B Bus	A Bus		21	32		
tphl		A 503		16	5 24	ns	
^t PLH	SBA†	A Bus	$R_{L} = 667 \Omega, C_{L} = 45 pF,$	38	3 57		
tphl	(with B high)	A Bus	See Note 2	26		ns	
^t PLH	SBA [†]		-	34	51		
^t PHL	(with B low)	A Bus		23		35 ns	
tPLH	SAB [†]			32			
^t PHL	(with A high)	B Bus		22		ns	
tPLH	SAB [†]			24			
tPHL	(with A low)	B Bus				ns	
tPLH	1		-				
^t PHL	ĞВА	A Bus		37		ns	
^t PZH	CAD		*				
tPZL	- GAB	B Bus	$R_{L} = 667 \Omega, C_{L} = 5 pF,$	25		ns	
^t PHZ	CAR		See Note 2	26			
tPLZ	GAB	B Bus		19		ns	

switching characteristics, V_{CC} = 5 V, T_A = $25 \,^{\circ}$ C

[†]These parameters are measured with the internal output state of the storage register opposite to that of the bus input. NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74LS651DW	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI
SN74LS651DWR	OBSOLETE	SOIC	DW	24		TBD	Call TI	Call TI
SN74LS651NT	OBSOLETE	PDIP	NT	24		TBD	Call TI	Call TI
SN74LS652DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS652DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS652DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS652DWR	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS652DWRE4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS652DWRG4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS652NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS652NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

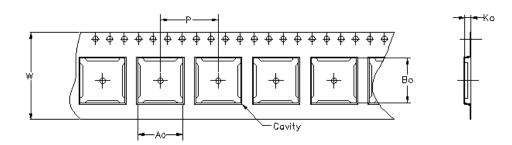
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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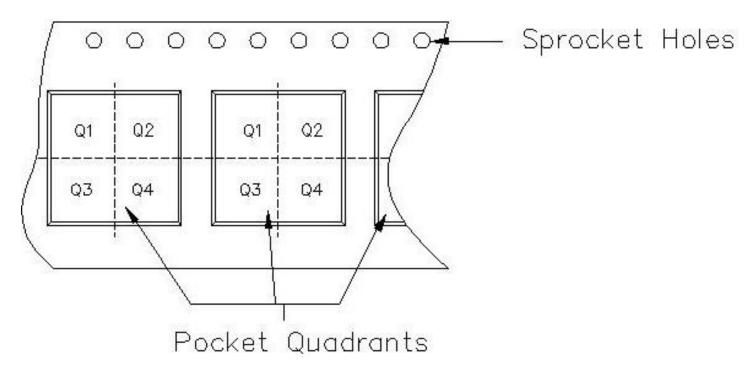


30-Apr-2007



Carrier tape design is defined largely by the component lentgh, width, and thickness.

Ao = Dimension designed to accommodate the component width.						
Bo = Dimension designed to accommodate the component length.						
Ko = Dimension designed to accommodate the component thickness.						
W = Overall width of the carrier tape.						
P = Pitch between successive cavity centers.						



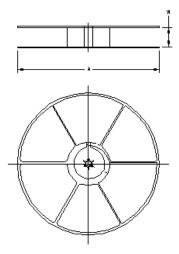
TAPE AND REEL INFORMATION

PACKAGE MATERIALS INFORMATION



30-Apr-2007

ſ	Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74LS652DWR	DW	24	TAI	330	24	10.75	15.7	2.7	12	24	Q1



TAPE AND REEL BOX INFORMATION

Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
SN74LS652DWR	DW	24	TAI	346.0	346.0	41.0
	~				HEXAT	r

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